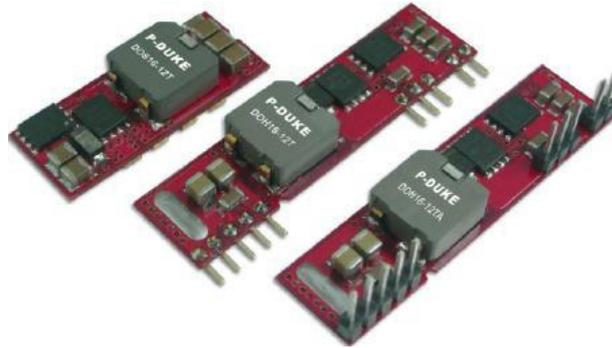3 YEARS WARRANTY

RoHS COMPLIANT

REACH COMPLIANT

Automation | Datacom | IPC

Industry | Measurement | Telecom

Automobile | Boat | Charger

Medical | PV | Railway

cULus CB CE

NO Min. Load Required | REMOTE ON OFF | OCP | SCP | UVP

PART NUMBER STRUCTURE

DOS16 - **12** **T** - **P**

Series Name	Input Voltage (VDC)		Package	Remote Control Options

DOS16: SMD TYPE
DOH16: SIP TYPE

12: 8.3~14

SMD TYPE **T:** No Assembly

SIP TYPE **T:** Vertical Mounting SIP
TA: Horizontal Mounting SIP

☐**:** Negative Logic
P: Positive Logic

TECHNICAL SPECIFICATION All specifications are typical at nominal input, full load and 25℃ unless otherwise noted

Model Number	Input Range VDC	Output Voltage VDC	Output Current @Full Load A	Input Current Vin(nom) @ No Load 0.75VDC / 5.0VDC mA	Efficiency Vin(nom),3.3VDC @Full Load %	Maximum Capacitor Load ESR≧1mΩ / ESR≧10mΩ µF
DOS16-12T						
DOS16-12T-P	Vout(set)≦3.63					
DOH16-12T	Vin = 8.3 ~ 14					
DOH16-12T-P		0.75 ~ 5	16	40 / 100	92	1000 / 5000
DOH16-12TA	Vout(set) > 3.63					
DOH16-12TA-P	Vin = 8.3 ~ 13.2					

INPUT SPECIFICATIONS

Parameter	Conditions		Min.	Typ.	Max.	Unit
Operating input voltage range	Vout(set)≦3.63VDC		8.3	12	14	VDC
	Vout(set) > 3.63VDC		8.3	12	13.2	
Maximum input current	Vin=8.3 to 14VDC, Io=Io(max.)			10		A
Start up voltage					8.3	VDC
Shutdown voltage			6.5	7.5	8	VDC
Input filter				Capacitor type		
	*It's necessary to equip the external input capacitors at the input of the module. The capacitors should connect as close as possible to the input terminals that ensuring module stability. The external C_{in} is 6pcs of 47µF ceramic capacitors at least.					

OUTPUT SPECIFICATIONS

| Parameter	Conditions		Min.	Typ.	Max.	Unit
Voltage accuracy		% of Vout(set)	-2.0		+2.0	%
Line regulation	Vin=Vin(min.) to Vin(max.) at Full Load	% of Vout(set)	-0.3		+0.3	%
Load regulation	No Load to Full Load	% of Vout(set)	-0.4		+0.4	%
Voltage adjustability			0.7525		5	VDC
Ripple and noise	Measured by 20MHz bandwidth,with a 1µF MLCC & a 10µF T/C				30	mVrms
					75	mVp-p
Temperature regulation	T_A= -40℃ to +85℃		-0.4		+0.4	%
Dynamic load response	With a 1µF MLCC & a 10µF T/C					
	ΔIo/Δt=2.5A/µs,Vin(nom) Peak deviation			200		mV
	50% load step change Setting time(Vout<10%peak deviation)			25		µs
	With 2pcs of 150µF polymer capacitors					
	ΔIo/Δt=2.5A/µs,Vin(nom) Peak deviation			100		mV
	50% load step change Setting time(Vout<10%peak deviation)			50		µs
Over load protection	% of Iout rated				180	%
Short circuit protection			Continuous, automatics recovery			
Output voltage overshoot-startup	Vin= Vin(min.) to Vin(max.) at Full Load	% of Vout(set)			1.0	%

GENERAL SPECIFICATIONS

Parameter	Conditions	Min.	Typ.	Max.	Unit
Isolation voltage			None		
Switching frequency		270	300	330	kHz
Safety meets			IEC/ EN/ UL62368-1		
Weight			6.0g (0.21oz)		
MTBF	MIL-HDBK-217F, Full load		3.416×10^6 hrs		

ENVIRONMENTAL SPECIFICATIONS

| Parameter	Conditions	Min.	Typ.	Max.	Unit
Operating ambient temperature	With derating	-40		+85	℃
Over temperature protection	Controller		125		℃
Storage temperature range		-55		+125	℃
Thermal shock			MIL-STD-810F		
Vibration			MIL-STD-810F		
Relative humidity(non-condensing)			5% to 95% RH		
Lead-free reflow solder process	Only for SMD type		IPC J-STD-020E		
Moisture sensitivity level(MSL)	Only for SMD type		IPC J-STD-033C Level 2a		

FEATURE SPECIFICATIONS

Parameter	Conditions			Min.	Typ.	Max.	Unit
Remote ON/OFF	Referred to GND pin	Negative logic (Standard)	DC-DC ON		Open or 0 ~ 0.3VDC		
			DC-DC OFF		2.5VDC ~ Vin(max.)		
		Positive logic (Option)	DC-DC ON		Open or (Vin-4) ~ Vin(max.)		
			DC-DC OFF		0 ~ 0.3VDC		
		Input current of Ctrl pin		0.01		1.0	mA
		Remote off input current			2.0		mA
	*Positive logic:ON/OFF is open collector/drain logic input Negative logic:ON/OFF pin is open collector/drain logic input with external pull –up resistor						
Remote sense range	If remote sense is not being used, +SENSE pin should connect to +Vout pin.					0.5	VDC
Rise time	Time for Vout to rise from 10% to 90%of Vout(set)					6	ms
Turn-on delay time	Case 1, Case 2				3		ms
	*Case 1: ON/OFF input is set to logic low (module on) and then input power is applied (delay from instant at which Vin=Vin(min.) until Vout=10% of Vout(set)) *Case 2:Input power is applied for at least one second and then the ON/OFF input is set to logic low (delay from instant at which Von/off=0.3VDC until Vout=10% of Vout(set))						

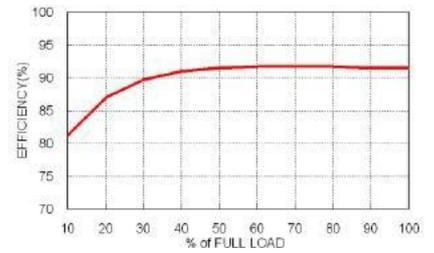**CAUTION:** This power module is not internally fused. An input line fuse must always be used.

CHARACTERISTIC CURVE
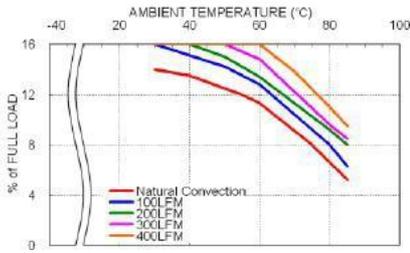
DOS16-12T, Vout=3.3V
Derating Curve
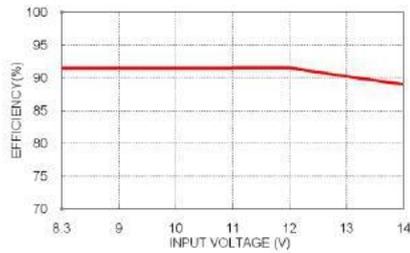
DOS16-12T, Vout=3.3V
Efficiency vs. Input Voltage

DOS16-12T, Vout=3.3V
Efficiency vs. Output Load

FUSE CONSIDERATION

This power module is not internally fused. An input line fuse must always be used.

This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of sophisticated power architecture.

To maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse.

The input line fuse suggest as below :

Model	Fuse Rating (A)	Fuse Type
DOS16-12T□□□	15	Fast-Acting
DOH16-12T□□□	15	Fast-Acting

The table based on the information provided in this data sheet on inrush energy and maximum DC input current at low Vin.
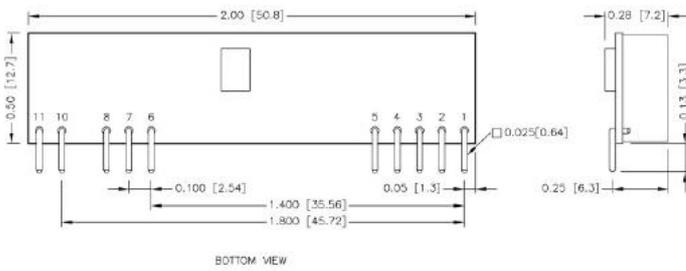
MECHANICAL DRAWING

DOS16-12T

BOTTOM VIEW
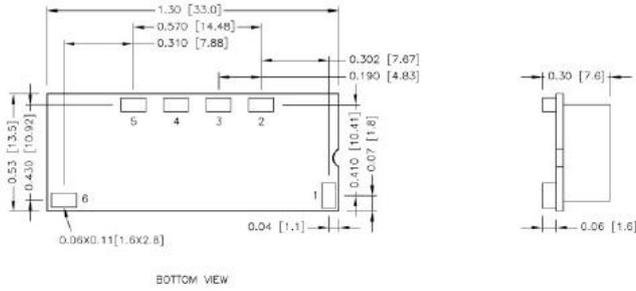
PIN CONNECTION

PIN	DEFINE
1	Ctrl
2	+Sense
3	Trim
4	+Vout
5	GND
6	+Vin

DOH16-12T

BOTTOM VIEW

PIN CONNECTION

PIN	DEFINE
1	+Vout
2	+Vout
3	+Sense
4	+Vout
5	GND
6	GND
7	+Vin
8	+Vin
10	Trim
11	Ctrl

DOH16-12TA

BOTTOM VIEW
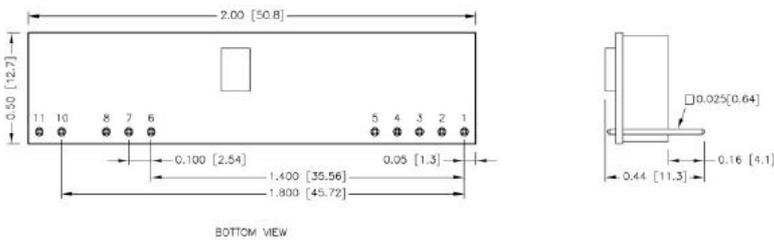
PIN CONNECTION

PIN	DEFINE
1	+Vout
2	+Vout
3	+Sense
4	+Vout
5	GND
6	GND
7	+Vin
8	+Vin
10	Trim
11	Ctrl

1. All dimensions in inch [mm]
2. Tolerance :x.xx±0.02 [x.x±0.5]
           x.xxx±0.01 [x.xx±0.25]
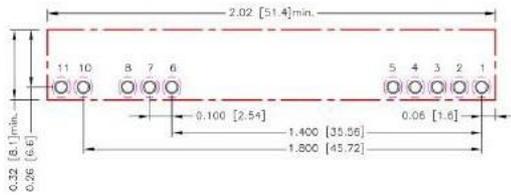3. Pin dimension tolerance ±0.004[0.10]
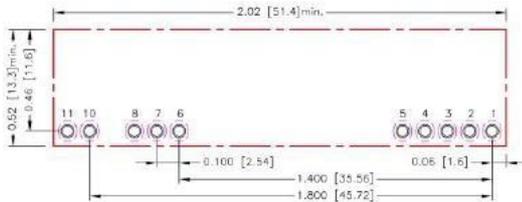
RECOMMENDED PAD LAYOUT

DOS16-12T
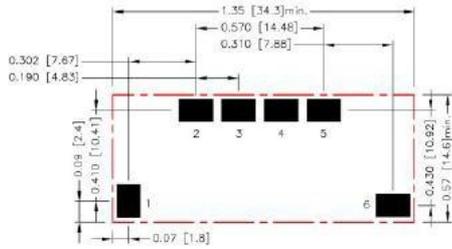
All dimensions in inch[mm]
Pad size(lead free recommended)
Top view pad1.2.3.4.5.6:0.150x0.102[3.80x2.60]

DOH16-12T

All dimensions in inch[mm]
Pad size(lead free recommended)
Through hole 1.2.3.4.5.6.7.8.10.11: Φ0.047[1.20]
Top view pad 1.2.3.4.5.6.7.8.10.11: Φ0.059[1.50]
Bottom view pad 1.2.3.4.5.6.7.8.10.11:
Groove R0.040[1.02]L-0.094[2.40]

DOH16-12TA

All dimensions in inch[mm]
Pad size(lead free recommended)
Through hole 1.2.3.4.5.6.7.8.10.11: Φ0.047[1.20]
Top view pad 1.2.3.4.5.6.7.8.10.11: Φ0.059[1.50]
Bottom view pad 1.2.3.4.5.6.7.8.10.11:
Groove R0.040[1.02]L-0.094[2.40]

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2022.04.13   Page 6

THERMAL CONSIDERATIONS

The power module operates in a variety of thermal environments;

however, sufficient cooling should be provided to help ensure reliable operation of the unit.

Heat is removed by conduction, convention, and radiation to the surrounding environment.

Proper cooling can be verified by measuring the point as the figure below.

The temperature at this location should not exceed 115℃.

When operating, adequate cooling must be provided to maintain the test point temperature at or below 115℃.

Although the maximum point temperature of the power modules is 115℃, you can limit this Temperature to a lower value for extremely high reliability.
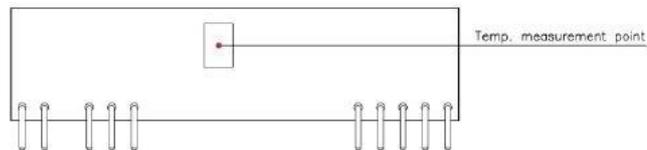
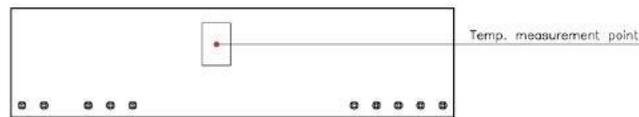■ Thermal test condition with vertical direction by natural convection (20LFM).

DOS16-12T

Temp. measurement point

BOTTOM VIEW

DOH16-12T

Temp. measurement point
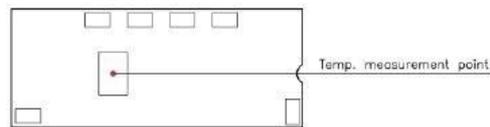
BOTTOM VIEW

**DOH16-12TA**

Temp. measurement point

BOTTOM VIEW

OUTPUT VOLTAGE PROGRAMMING

Output voltage programmable from 0.7525V to 5V by connecting a single resistor (shown as Trim Table) between the Trim and GND pins of the module.
To calculate the value of the resistor Rtrim for a particular output voltage Vout, use the following equation:

■ **Rtrim Equation :** $Rtrim = \left[\dfrac{10500}{Vout - 0.7525} - 1000 \right] \Omega$

Trim Figure

+Vin +Vout

TRIM LOAD

GND Rtrim
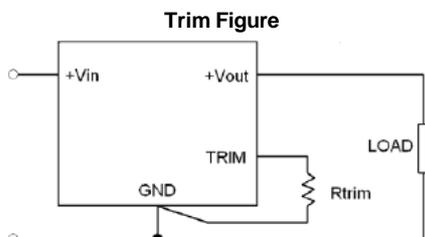
Trim Table

Vout(set) (VDC)	Rtrim (kΩ)
0.7525	Open
1.2	22.46
1.5	13.05
1.8	9.024
2.5	5.009
3.3	3.122
5	1.472

LEAD FREE REFLOW PROFILE   For SMD Type

Peak Temp. : 240-245℃
Peak Time : 10 sec. max.

Ramp Up Temp:217~Peak°C
Ramp Up Rate : 1~3℃/sec
Melting Time : 30~60 sec

300

TEMPERATURE (℃)

217℃
200℃

217℃

200

150℃

100

PREHEAT ZONE
Preheat Time: 60~120 sec.

ACTUAL
HEATING

COOLING

0

0   100   200   300

TIME
(sec)

Ramp Up Temp:50~150°C
Ramp Up Rate:1~3°C

Ramp Down Temp:217~150°C
Ramp Down Rate:-1~-5°C/sec
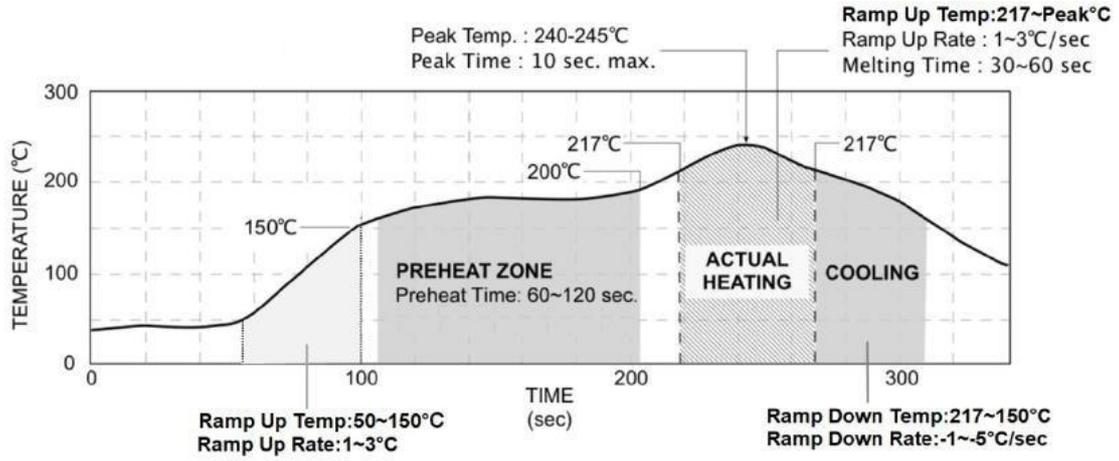
*The curves define the maximum peak reflow temperature permissible measured on pin1 or Vin pin.